

Transistor (NPN)

Features

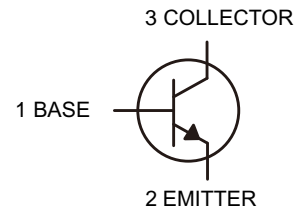
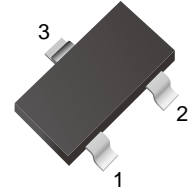
- NPN epitaxial silicon , planar design
- Collector-emitter voltage $V_{CE}=50V$
- Collector current $I_C=0.15A$
- Lead free in comply with EU RoHS 2011/65/EU directives

Mechanical Data

- Case: SOT-23
- Approx. Weight: 8.1mg

Ordering Information

Part Number	Marking	Shipping	Reel
LT2C1623-TR3	L6	3000PCS Tape&Reel	7 inches
LT2C1623-TR12	L6	12000PCS Tape&Reel	13 inches



Maximum Ratings ($T_a=25$ unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	60	V
V_{CEO}	Collector-Emitter Voltage	50	V
V_{EBO}	Emitter-Base Voltage	7	V
I_C	Collector Current	150	mA
P_C	Collector Power Dissipation	225	mW
$R_{\theta JA}$	Thermal Resistance From Junction To Ambient	625	$^{\circ}C/W$
T_j	Junction Temperature	150	$^{\circ}C$
T_{stg}	Storage Temperature	-55~+150	$^{\circ}C$

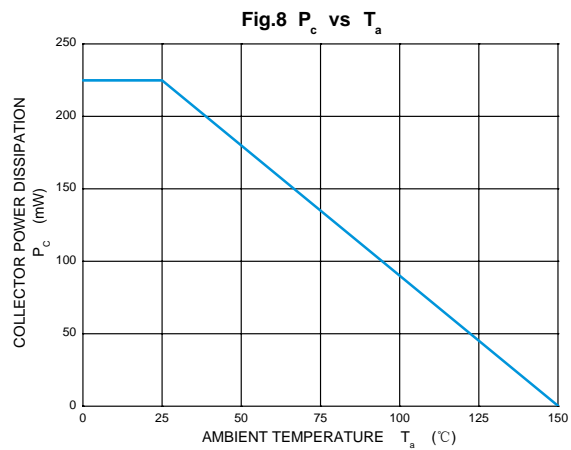
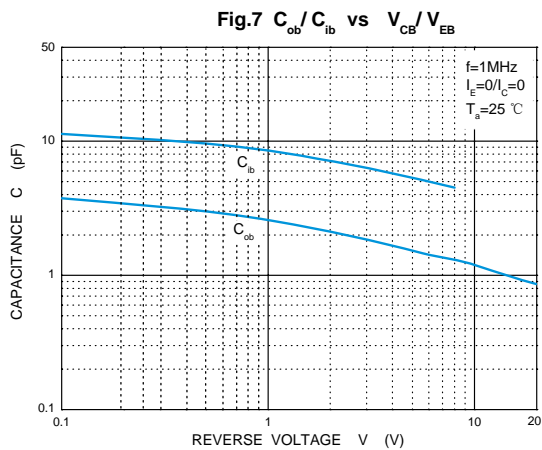
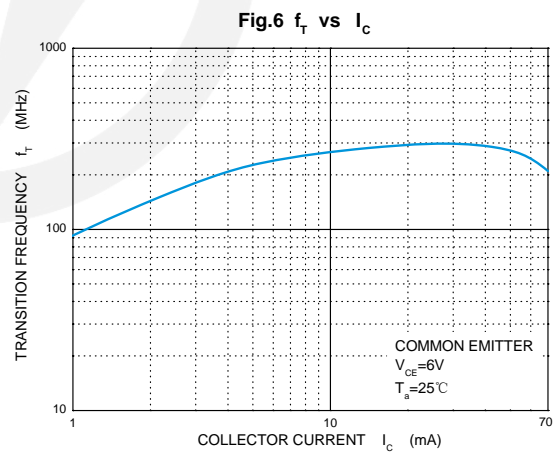
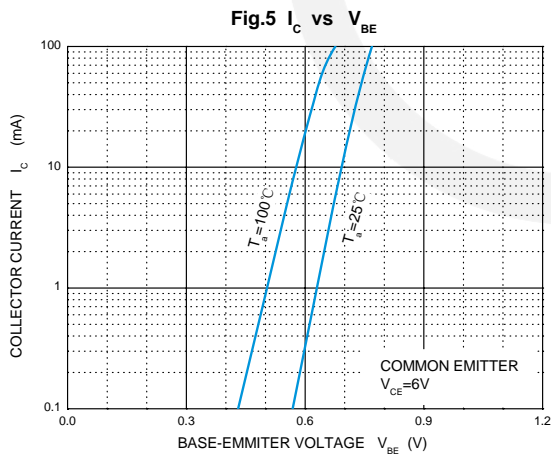
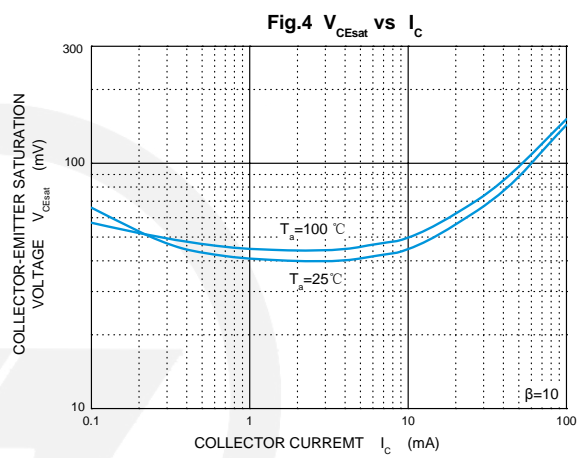
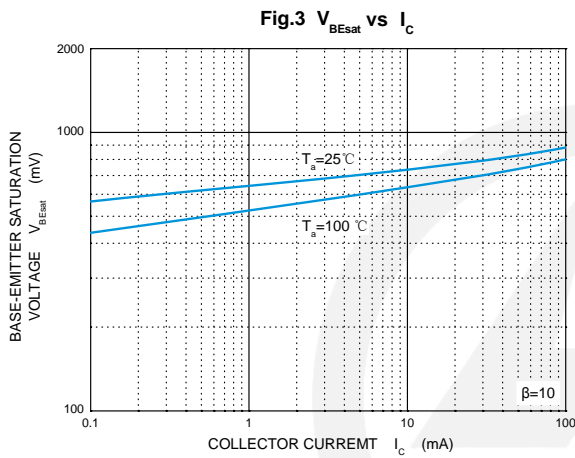
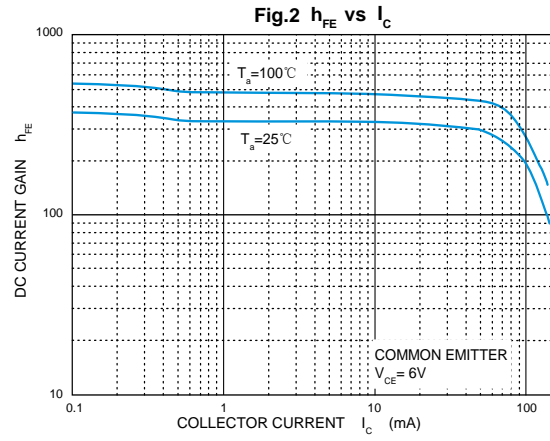
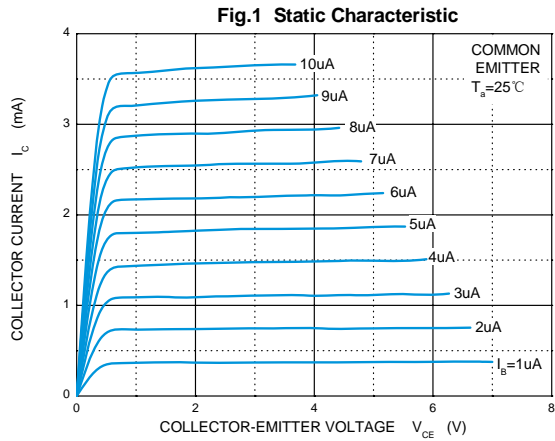
Electrical characteristics ($T_a=25$ unless otherwise specified)

Parameter	Symbol	Test condition	Min	Typ	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C=0.1mA, I_E=0$	60			V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	$I_C=1mA, I_B=0$	50			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=0.1mA, I_C=0$	7			V
Collector cut-off current	I_{CBO}	$V_{CB}=60V, I_C=0$			0.1	μA
Emitter cut-off current	I_{EBO}	$V_{EB}=5V, I_C=0$			0.1	μA
Collector cut-off current	I_{CEO}	$V_{CE}=35V, I_B=0$			0.5	μA
DC current gain*	h_{FE}	$V_{CE}=6V, I_C=1mA$	200		400	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=100mA, I_B=10mA$			0.3	V
Base-emitter saturation voltage *	$V_{BE(sat)}$	$I_C=100mA, I_B=10mA$			1	V
Transition frequency	f_T	$V_{CE}=6V, I_C=10mA, f=30MHz$		250		MHz
Output Capacitance	C_{ob}	$V_{CB}=6V, f=1MHz$		3		pF

*Pulse Test: Pulse Width<300 μ S, Duty Cycle<2.0%.



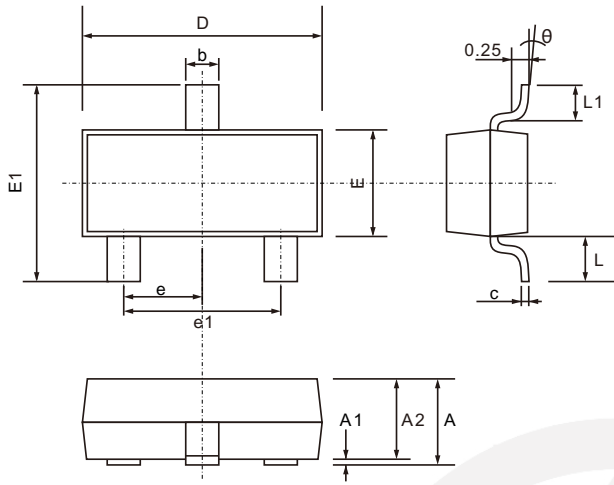
Characteristics Curves





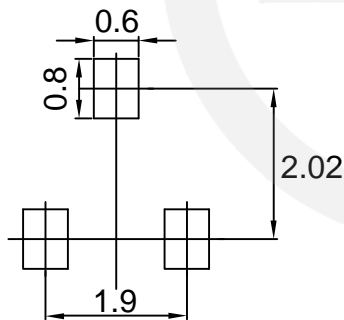
SOT-23 Package Outline

Unit: mm



SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.900	1.200
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.200
D	2.700	3.100
E	1.200	1.400
E1	2.200	2.600
e	0.950 TYP.	
e1	1.750	2.050
L	0.550 TYP.	
L1	0.300	0.500
θ	0°	8°

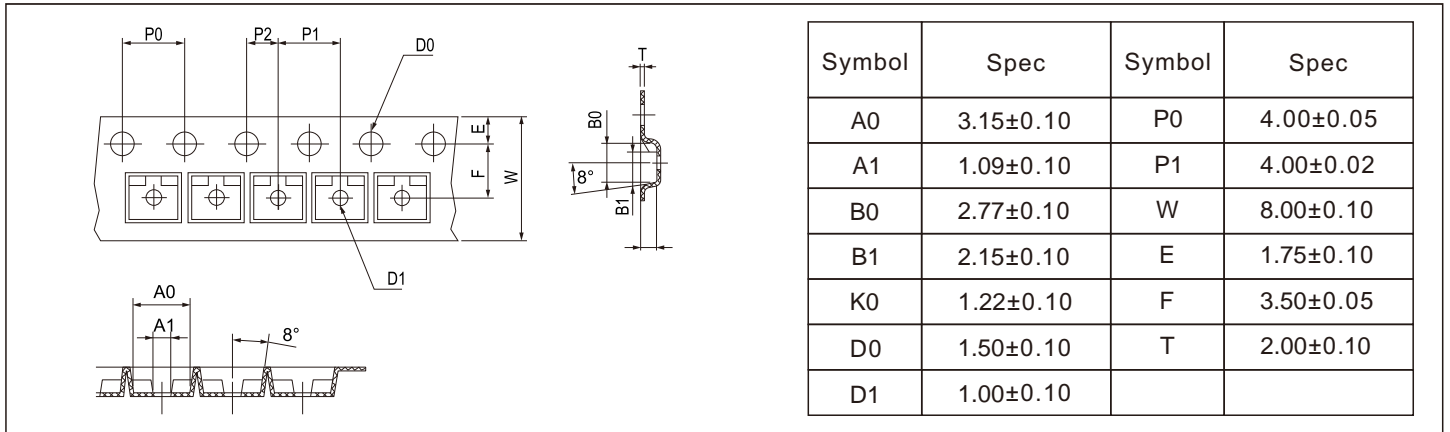
SOT-23 Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$
 3. The pad layout is for reference purpose only.

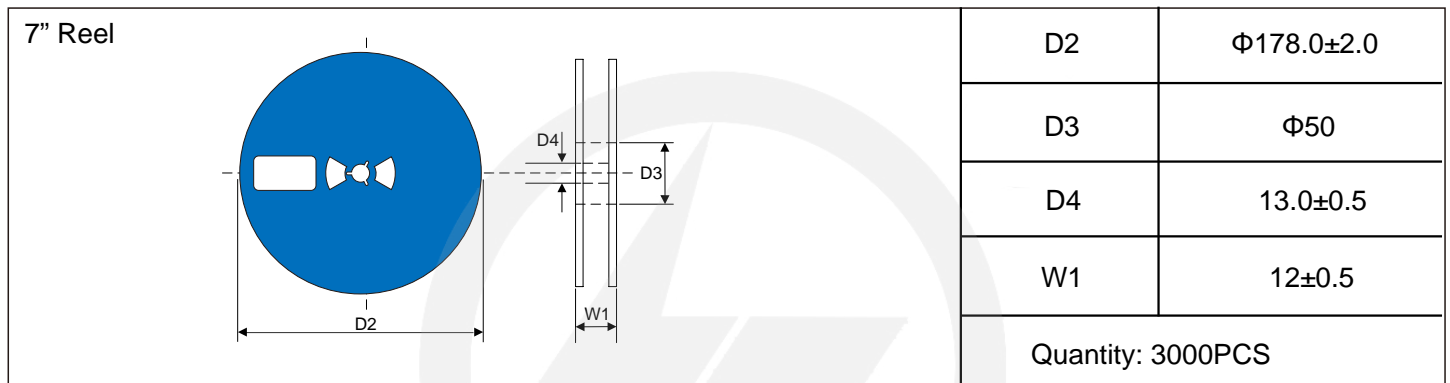
Carrier Tape Dimensions

Unit : mm



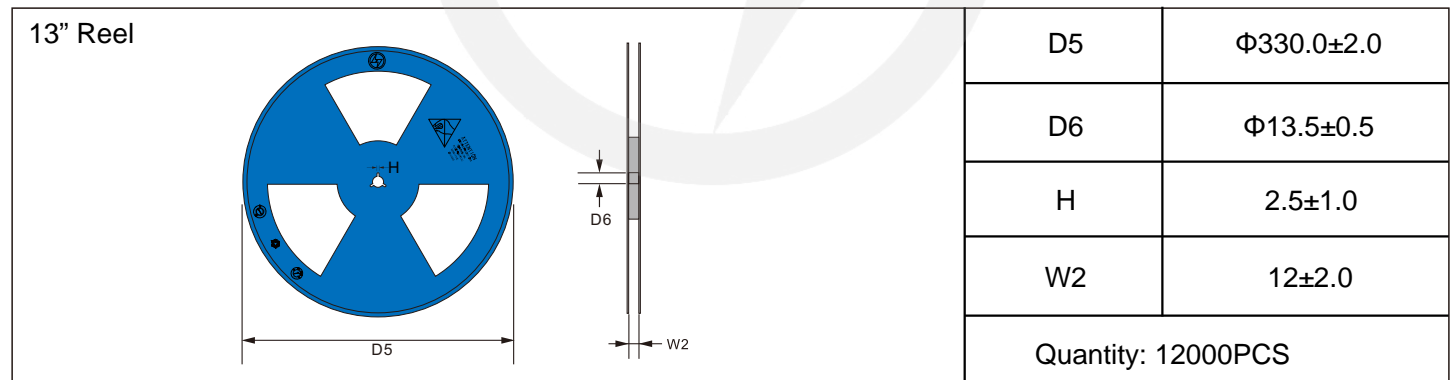
Reel Dimensions

Unit : mm

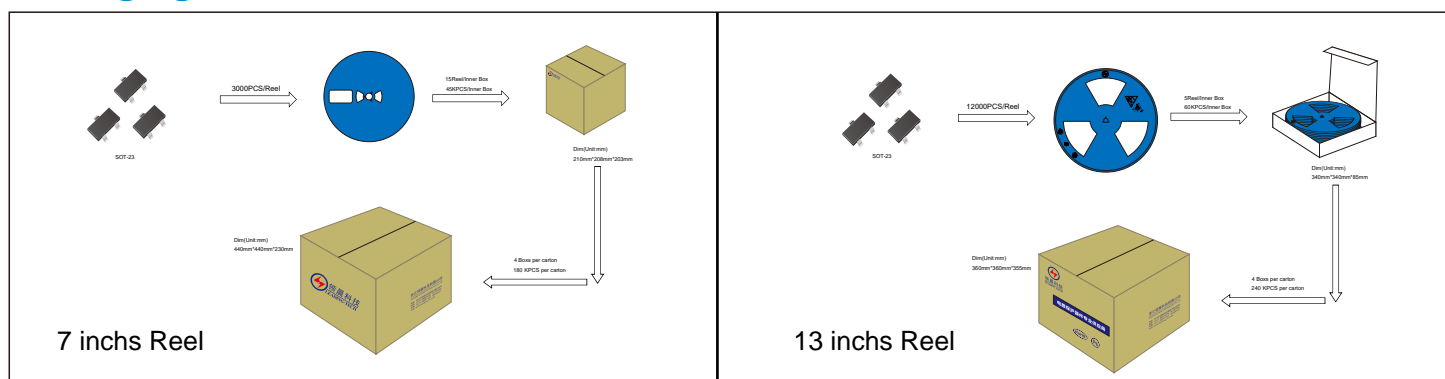


Reel Dimensions

Unit : mm



Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T _L to T _P)	3°C/second max.
Preheat	
-Temperature Min (T _{S min})	150°C
-Temperature Max (T _{S max})	200°C
-Time (min to max) (t _s)	60-180 seconds
T _{S max} to T _L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T _L)	217°C
-Time (t _L)	60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (t _p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

Important Notice and Disclaimer

Leading-Tech reserves the right to make changes to this document and its products and specifications at any time without notice.

Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

Leading-Tech makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, not does Leading-Tech assume any liability for application assistance or customer product design.

Leading-Tech does not warrant or accept any liability with products which are purchase or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of Leading-Tech.

Leading-Tech products are not authorized for use as critical components in life support devices or systems without express written approval of Leading-Tech.

Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision Content	Revision Reason	Revision Person	Note
01	2024.03.12	2024.03.12	3.0	New file	/	Ding	
02	2025.06.12	2025.06.12	3.1	Update packaging information	/	Ding	
03	2026.03.06	2026.03.06	3.2	Package outline E1(max)=2.6mm	/	Ding	